

#### HIGH-SIDE AND LOW-SIDE GATE DRIVER IN SO-14 (Type TH)

#### Description

The DGD21814 is a high-voltage/high-speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a half-bridge configuration. High-voltage processing techniques enable the DGD21814's high-side to switch to 600V in a bootstrap operation.

The DGD21814 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) for easy interfacing with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction.

The DGD21814 is offered in SO-14 package and the operating temperature extends from -40°C to +125°C.

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Typical Configuration

DGD21814

#### Applications

- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers

Vcc o

HIN C

LIN O

#### Features

- Floating High-side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge Configuration
- 1.9A Source / 2.3A Sink Output Current Capability
- Outputs Tolerant to Negative Transients
- Wide Low-side Gate Driver and Logic Supply: 10V to 20V
- Logic Input (HIN and LIN) 3.3V Capability
- Schmitt Triggered Logic Inputs with Internal Pull Down
- Undervoltage Lockout for High and Low Side Drivers
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
- https://www.diodes.com/quality/product-definitions/

# Mechanical Data

- Case: SO-14 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish—Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.142 grams (Approximate)



Top View

### Ordering Information (Note 4)

HIN

LIN Vss

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
DGD21814S14-13	DGD21814	13	16	2500

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

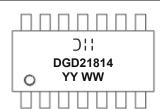
Up to 600

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TO LO

#### **Marking Information**

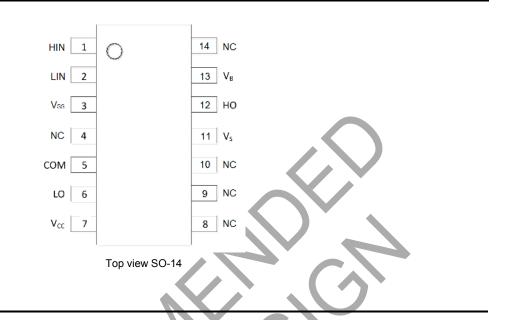
Notes:



)'! = Manufacturer's marking DGD21814 = Product Type Marking Code YY = Year (ex: 19 = 2019) WW = Week (01 to 53)



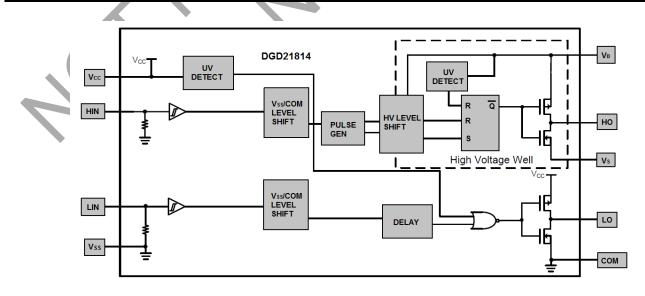
#### **Pin Diagrams**



#### **Pin Descriptions**

Pin Number	Pin Name	Function
1	HIN	Logic input for high-side gate driver output, in phase with HO
2	LIN	Logic input for low-side gate driver output, in phase with LO
3	Vss	Logic ground
4, 8, 9, 10, 14	NC	No connection (No Internal Connection)
5	COM	Low-side and logic return
6	LO	Low-side gate drive output
7	Vcc	Low-side and logic fixed supply
11	Vs	High-side floating supply return
12	HO	High-side gate drive output
13	VB	High-side floating supply

# Functional Block Diagram





#### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
High-side Floating Supply Voltage	VB	-0.3 to +624	V	
High-side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V	
High-side Floating Output Voltage	V <sub>HO</sub>	V <sub>S</sub> -0.3 to V <sub>B</sub> +0.3	V	
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns	
Low-side Fixed Supply Voltage	V <sub>CC</sub>	-0.3 to +24	V	
Logic Supply Offset Voltage	V <sub>SS</sub>	V <sub>CC</sub> -24 to V <sub>CC</sub> +0.3	V	
Low-side Output Voltage	V <sub>LO</sub>	-0.3 to V <sub>CC</sub> +0.3	V	
Logic Input Voltage (HIN and LIN)	V <sub>IN</sub>	-0.3 to V <sub>CC</sub> +0.3	V	

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	1.0	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>eja</sub>	120	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

# **Recommended Operating Conditions**

Symbol	Min	Max	Unit
VB	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
Vs	(Note 6)	600	V
V <sub>но</sub>	Vs	VB	V
Vcc	10	20	V
VLO	0	V <sub>CC</sub>	V
Vin	0	V <sub>CC</sub>	V
V <sub>SS</sub>	-5	5	V
T <sub>A</sub>	-40	+125	°C
	V <sub>B</sub> Vs VHO V <sub>CC</sub> VLO VIN	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Note: 6. Logic operation for  $V_S$  of -5V to +600V.





# DC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, @T<sub>A</sub> = +25°C, unless otherwise specified.) (Note 7)

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Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage (Note 8)	VIH	2.5	—	_	V	$V_{CC}$ = 10V to 20V
Logic "0" Input Voltage (Note 8)	VIL	—	—	0.8	V	V <sub>CC</sub> = 10V to 20V
High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	V <sub>OH</sub>	—	—	1.4	V	$I_0 = 0 m A$
Low Level Output Voltage, V <sub>O</sub>	Vol	—	—	0.2	V	I <sub>O</sub> = 20mA
Offset Supply Leakage Current	I <sub>LK</sub>	—	—	50	μA	$V_{B} = V_{S} = 600V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	20	60	150	μA	V <sub>IN</sub> = 0V or 5V
Quiescent V <sub>CC</sub> Supply Current	Iccq	50	120	240	μA	V <sub>IN</sub> = 0V or 5V
Logic "1" Input Bias Current	I <sub>IN+</sub>	—	25	60	μA	V <sub>IN</sub> = 5V
Logic "0" Input Bias Current	I <sub>IN-</sub>	—	—	5.0	μA	V <sub>IN</sub> = 0V
V <sub>BS</sub> Supply Undervoltage Positive Going Threshold	V <sub>BSUV+</sub>	8.0	8.9	9.8	V	_
V <sub>BS</sub> Supply Undervoltage Negative Going Threshold	V <sub>BSUV-</sub>	7.4	8.2	9.0	V	<u> </u>
V <sub>CC</sub> Supply Undervoltage Positive Going Threshold	V <sub>CCUV+</sub>	8.0	8.9	9.8	V	—
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	V <sub>CCUV-</sub>	7.4	8.2	9.0	V	_
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	1.4	1.9	—	A	Vo = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	I <sub>O-</sub>	1.8	2.3		A	V <sub>O</sub> = 15V, PW ≤ 10µs

Note: 7. The V<sub>IN</sub> and I<sub>IN</sub> parameters are applicable to the two logic input pins: HIN and LIN. The V<sub>0</sub> and I<sub>0</sub> parameters are applicable to the respective output pins: HO and LO.

8. For optimal operation, it is recommended that the input pulses (HIN and LIN) should have a minimum amplitude of 2.5V with a minimum pulse width of 360ns.

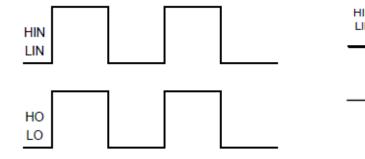
# AC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, C<sub>L</sub> = 1,000pF, @T<sub>A</sub> = +25°C, unless otherwise specified.)

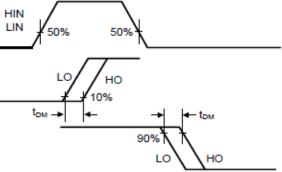
Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-on Propagation Delay	t <sub>ON</sub>		180	270	ns	$V_{\rm S} = 0V$
Turn-off Propagation Delay	toff	+	220	330	ns	V <sub>S</sub> = 0V or 600V
Delay Matching, HO & LO Turn-on/off	t <sub>DM</sub>			35	ns	—
Turn-on Rise Time	tr		40	60	ns	$V_{\rm S} = 0V$
Turn-off Fall Time	tr		20	35	ns	$V_{\rm S} = 0V$





### **Timing Waveforms**





### Figure 1. Input / Output Timing Diagram

Figure 2. Delay Matching Waveform Definitions

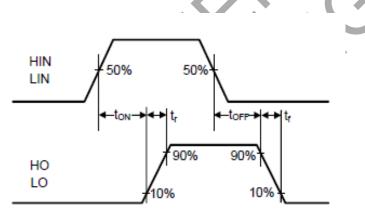


Figure 3. Switching Time Waveform Definitions



### Typical Performance Characteristics (Vcc=15V, @TA = +25°C, unless otherwise specified.)

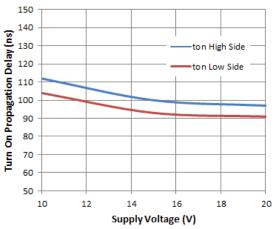


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

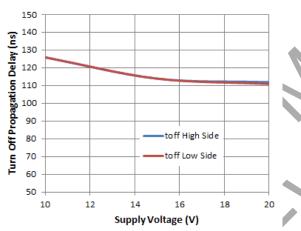


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

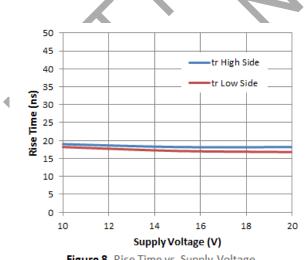


Figure 8. Rise Time vs. Supply Voltage

140 Turn On Propagation Delay (ns) 130 120 110 100 90 80 ton High Side 70 ton Low Side 60 50 -20 -40 0 20 40 60 80 100 120 Temperature (°C) Figure 5. Turn-on Propagation Delay vs. Temperature

150

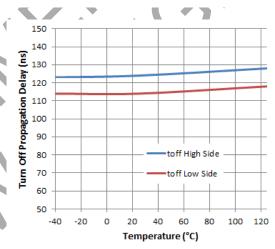
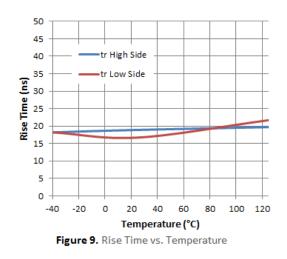
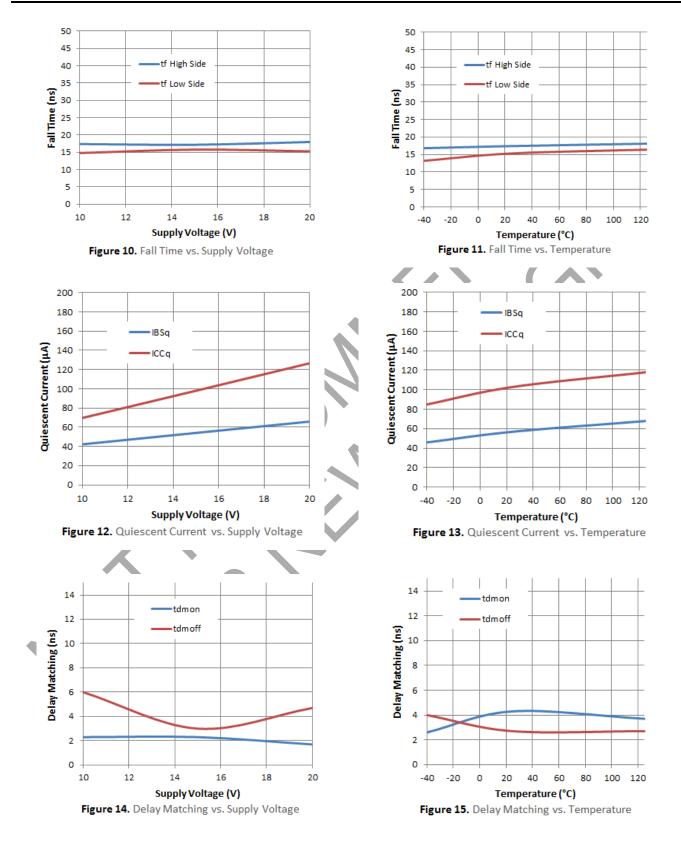


Figure 7. Turn-off Propagation Delay vs. Temperature



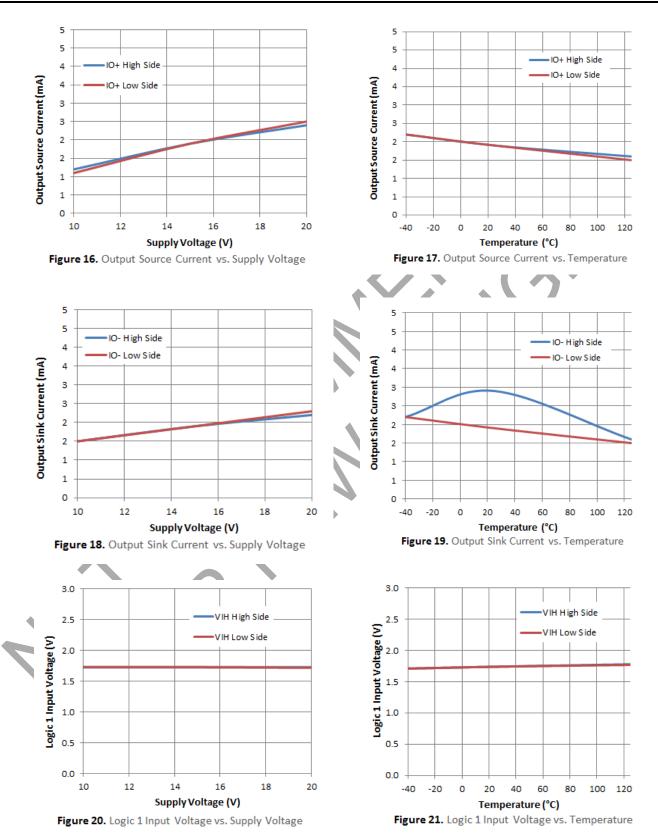


# Typical Performance Characteristics (Cont.)



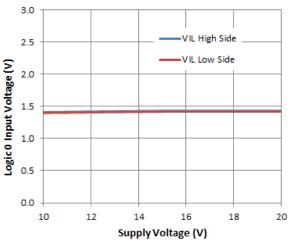


### Typical Performance Characteristics (Cont.)

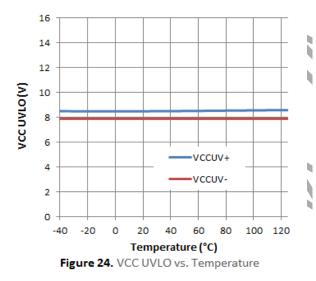




### Typical Performance Characteristics (Cont.)







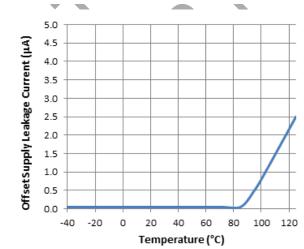
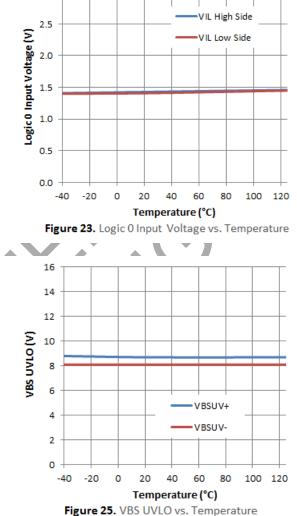


Figure 26. Offset Supply Leakage Current vs. Temperature

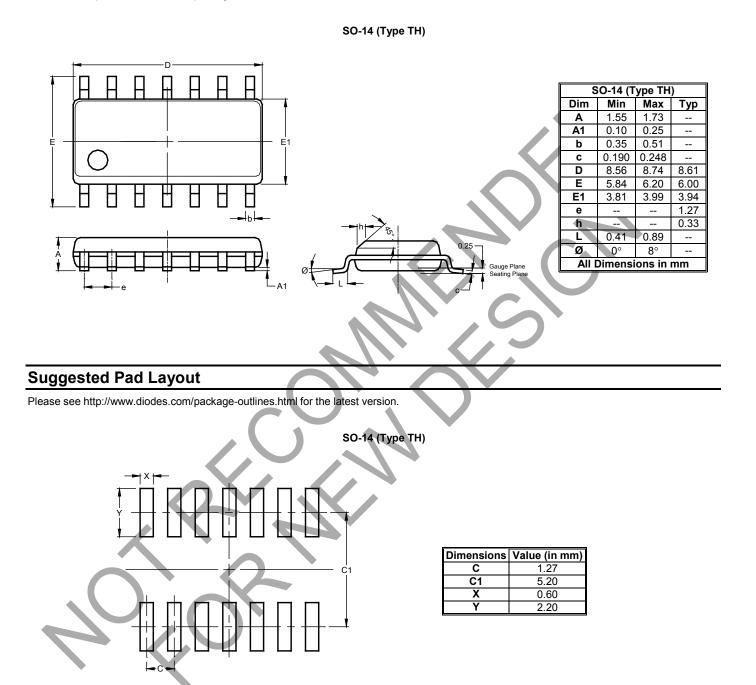


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#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





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